



Product Change Notification

Change Notification #: 118013 - 00
Change Title: Intel® Dual Band Wireless-AC 8260
SKUs: 8260.NGWMG.NV, 8260.NGWMG.K,
PCN 118013-00, Label,
Label Updates
Date of Publication: January 5, 2021

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	February 1, 2021
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Description of Change to the Customer:

The Intel® Dual Band Wireless-AC 8260 SKUs listed in the products affected table below will undergo the following changes.

1. Product TA# dash up to incorporate label documentation updates.
2. The Intel Tracking revision will be changed on the following products.

Product Code	Before	After
8260.NGWMG.K	0I	0J
8260.NGWMG.NV	0I	0J

8260.NGWMG.K Product Label - Before



8260.NGWMG.K Product Label - Before



8260.NGWMG.K Disti Label - Before

8260.NGWMG.K VERSION #: H98367-010 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX	QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS	1 88334 00140 2 9 310779 300005	Intel® Dual Band Wireless-AC 8260 (Model: 8260NGW)	<table border="1"> <tr> <td>AT</td><td>BE</td><td>BG</td><td>CH</td><td>CY</td><td>CZ</td><td>DE</td> </tr> <tr> <td>DK</td><td>EE</td><td>EL</td><td>ES</td><td>FI</td><td>FR</td><td>HR</td> </tr> <tr> <td>HU</td><td>IE</td><td>IS</td><td>IT</td><td>LI</td><td>LT</td><td>LU</td> </tr> <tr> <td>LV</td><td>MT</td><td>NL</td><td>PL</td><td>PT</td><td>RO</td><td>SE</td> </tr> <tr> <td>SI</td><td>SK</td><td>TR</td><td>UK</td><td></td><td></td><td></td> </tr> </table> Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com	AT	BE	BG	CH	CY	CZ	DE	DK	EE	EL	ES	FI	FR	HR	HU	IE	IS	IT	LI	LT	LU	LV	MT	NL	PL	PT	RO	SE	SI	SK	TR	UK			
			AT		BE	BG	CH	CY	CZ	DE																													
DK	EE	EL	ES	FI	FR	HR																																	
HU	IE	IS	IT	LI	LT	LU																																	
LV	MT	NL	PL	PT	RO	SE																																	
SI	SK	TR	UK																																				
PKG ID (3S) VVVVMMMMDDDD#####PPPPPP100 T P/N: GTTTTTTTTTT																																							
D P/N: PPPPPP REV AXJ HP P/N: 843075-001 REV: 0I PACKAGE WEIGHT: X.X LBS																																							
Vendor ID Loc Id Mfg Id VVVVV LLLLL MMMMM	L P/N: XXXXXXXXXX EC: XXXXXX																																						

8260.NGWMG.K Disti Label - After

8260.NGWMG.K VERSION #: H98367-011 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX	QTY: 100 MM#: XXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVYMDRSS	1 88334 00140 2 9 310779 300005	Intel® Dual Band Wireless-AC 8260 (Model: 8260NGW)	<table border="1"> <tr> <td>AT</td><td>BE</td><td>BG</td><td>CH</td><td>CY</td><td>CZ</td><td>DE</td> </tr> <tr> <td>DK</td><td>EE</td><td>EL</td><td>ES</td><td>FI</td><td>FR</td><td>HR</td> </tr> <tr> <td>HU</td><td>IE</td><td>IS</td><td>IT</td><td>LI</td><td>LT</td><td>LU</td> </tr> <tr> <td>LV</td><td>MT</td><td>NL</td><td>PL</td><td>PT</td><td>RO</td><td>SE</td> </tr> <tr> <td>SI</td><td>SK</td><td>TR</td><td>UK</td><td></td><td></td><td></td> </tr> </table> Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com	AT	BE	BG	CH	CY	CZ	DE	DK	EE	EL	ES	FI	FR	HR	HU	IE	IS	IT	LI	LT	LU	LV	MT	NL	PL	PT	RO	SE	SI	SK	TR	UK			
			AT		BE	BG	CH	CY	CZ	DE																													
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Vendor ID Loc Id Mfg Id VVVVV LLLLL MMMMM	L P/N: XXXXXXXXXX EC: XXXXXX																																						

8260.NGWMG.NV Product Label - Before

H85072-004



Intel® Model: 8260NGW
 FCC ID: PD98260NG
 Anatel: 2607-15-2198

SPS : 806722-001 0I
 WFM: OOOOOOXXXXXX
 BDM: OOOOOOXXXXXX

MM: XXXXXX
 TA: H84009-011
 Made in Xxxxx



CE, FCC, and other regulatory logos.

MSIP-CRM-INT-8260NGW
 PTA APPROVED MODEL
 CMIIT ID: 2015AJ2225 (M)
 003-150093
 5.15-5.35 GHz: Indoor
 use only (except
 communicate to
 high power radio)
 D150069003
 CCAH15LP0910T2
 IC :1000M-8260NG

8260.NGWMG.NV Product Label - Before

H85072-004



Intel® Model: 8260NGW
 FCC ID: PD98260NG
 Anatel: 2607-15-2198

SPS : 806722-001 0J
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MSIP-CRM-INT-8260NGW
 PTA APPROVED MODEL
 CMIIT ID: 2015AJ2225 (M)
 003-150093
 5.15-5.35 GHz: Indoor
 use only (except
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 high power radio)
 D150069003
 CCAH15LP0910T2
 IC :1000M-8260NG

8260.NGWMG.NV Disti Label - Before

<p>8260.NGWMG.NV</p>  <p>VERSION #: H84009-011</p>  <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX</p>	<p>QTY: 100</p> <p>MM#: XXXXXX</p>  <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVVYMDRSS</p> 	 <p>1 88334 00140 2</p> <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 8260 (Model: 8260NGW)</p> <p>PKG ID (3S) VVVVMMMMDDDD###PPPPPP100 T P/N: GTTTTTTTTT</p> <p>D P/N: P P P P P P REV AX HP P/N: 806497-001 REV: 0I PACKAGE WEIGHT: XX LBS</p> <p>Vendor ID Loc Id Mfg Id VVVVVJLLLL M M M M M</p> <p>L P/N: XXXXXXXXXXXX EC: XXXXXX</p>	 <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>MSIP-CRM-INT-8260NGW</p>
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8260.NGWMG.NV Disti Label - After

<p>8260.NGWMG.NV</p>  <p>VERSION #: H84009-012</p>  <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX</p>	<p>QTY: 100</p> <p>MM#: XXXXXX</p>  <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVVYMDRSS</p> 	 <p>1 88334 00140 2</p> <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 8260 (Model: 8260NGW)</p> <p>PKG ID (3S) VVVVMMMMDDDD###PPPPPP100 T P/N: GTTTTTTTTT</p> <p>D P/N: P P P P P P REV AX HP P/N: 806497-001 REV: 0J PACKAGE WEIGHT: XX LBS</p> <p>Vendor ID Loc Id Mfg Id VVVVVJLLLL M M M M M</p> <p>L P/N: XXXXXXXXXXXX EC: XXXXXX</p>	 <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>MSIP-CRM-INT-8260NGW</p>
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Customer Impact of Change and Recommended Action:

The label changes to the products do not affect functionality. Intel anticipates no impact to customers.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
8260.NGWGMG.NV	942167	H84009-011	H84009-012
8260.NGWGMG.K	947412	H98367-010	H98367-011

PCN Revision History:

Date of Revision:

January 5, 2021

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

118013 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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